

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

| | | | | | | (| / | |
|--|---------------------|--|--|--------------|-------------------------|-------------|-----------------------|--------------------|
| PCN #: A1905-01 DATE: 11- | | 11-Jun-2019 | MEANS OF DISTINGUISHING CHANGED DEVICES: | | | | D DEVICES: | |
| Product Affected: QS | SOP-16 | | | □ Produc | t Mark | Lot # will | have | |
| (R | Refer to Attachment | II for the | affected part#) | Back N | /lark | | | n, Malaysia (M |
| , , , , , , , , , , , , , , , , , , , | | | • / | Date C | ode | site) | | 1, 1v1a1ay51a (1v1 |
| | | | | □ Other | | 5100) | | |
| Date Effective: 11-S | Sep-2019 | | | | | | | |
| Contact: IDT P | PCN DESK | | | Attachmer | nt: | Yes | | No |
| E-mail: pcnde | esk@idt.com | | | Samples: | Please con sample re | | local sales rep | resentative for |
| DESCRIPTION AND F | PURPOSE OF CH | ANGE: | | | | | | |
| □ Die Technology | | | | | | | | |
| □ Wafer Fabrication Pr | | This notification is to advise our customers that IDT is adding Carsem, Malaysia (M | | | | | | |
| Assembly Process | | site) as an alternate assembly facility as one of the existing assembly facility, OSET has discontinued the package. | | | | | | |
| Equipment | 11 | | tillided the pack | ine package. | | | | |
| MaterialTesting | Т | There is no change to the moisture performance. | | | | | | |
| I resulting Manufacturing Site | | | | 1.0. | 1. | | | |
| | | ent I details the qualification results. ent II lists the affected part numbers. | | | | | | |
| □ Other | | liacinnei | | cieu part n | unioers. | | | |
| | | | | | | | | |
| RELIABILITY/QUAL | LIFICATION SUM | MARY | : | | | | | |
| Refer to qualification da | ata shown in Attach | ment I. | | | | | | |
| CUSTOMER ACKNO | WLEDGMENT O | F RECH | EIPT: | | | | | |
| IDT records indicate the | | | | nge Please | use the ac | knowledge | ement helow o | r F-Mail |
| to grant approval or req | | | | - | | - | | |
| it will be assumed that t | - | | | | | | | |
| | | | ctured after the p | process cha | nge effecti | ve date unt | til the inventor | ry |
| IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted. | | | | | | | | |
| | 1 | | | | | | | |
| Customer: | | | _ 🗆 | Appro | oval for s | shipment | s prior to e <u>j</u> | ffective date. |
| Name/Date: | | | E- | Mail Addre | ess: | | | |
| | | | hone# /Fax# : | | | | | |
| | | | | | | | | |
| CUSTOMER COMMI | ENTS: | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |
| IDT ACKNOWLEDGMENT OF RECEIPT: | | | | | | | | |
| RECD. BY: | | | | DATE: | | | | |
| | | | | - | | | | |



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ATTACHMENT I - PCN # : A1905-01

| PCN Type: | Alternate Assembly Location & Change of Material Sets | | | |
|--------------------|---|--|--|--|
| Data Sheet Change: | None | | | |
| | No change in moisture sensitivity level (MSL) | | | |

Detail Of Change:

This notification is to advise our customers that IDT is adding Carsem, Malaysia (M site) as an alternate assembly facility as one of the existing assembly facility, OSET has discontinued the package.

The material set details of the current and alternate assembly location is as shown in Table 1. There will be no change in wire type as a result of this PCN. Customers receiving products assembled in Gold wire will continue to receive Gold wire parts and vice versa except for some select part numbers as stated below.

There is no change to the moisture performance rating but the material declaration will differ.

Table 1: Assembly Material Sets for The Existing and Alternate Assembly Location

| | Existi | ng | Future | | |
|----------------------------|-----------------------------|-----------------------|-----------------------------|-------------------------------------|--|
| Material Set / Assembly | ATP - Amkor, Philippines | OSET - OSE, Taiwan | ATP - Amkor, Philippines | CRSM - Carsem, Malaysia (M site) | |
| Die Attach | Ablestik 8290 | EN4900GC | Ablestik 8290 | 84-1 LMI SR4 | |
| Bonding Wire | Gold wire, Copper wire | Gold wire | Gold wire, Copper wire | Gold wire, Copper wire* | |
| Mold Compound | EME-G600 | CEL-9220HF | EME-G600 | CEL-8240HF | |

* Copper wire for part# 9112BF-17LF(T)



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ATTACHMENT I - PCN # : A1905-01

Qualification Information and Qualification Data:

- Affected Packages: QSOP-16
- Assembly Material: Shown on page 2 of this attachment.
- Qual Plan & Results: Tests are in accordance with JEDEC47 recommended tests.

Qualification Vehicle: QSOP-20 (Gold wire) & QSOP-28 (Copper wire)

| | | Test Results Gold wire & Copper wire (Rej / SS) | | | |
|---|------------------------------|--|------------|------------|--|
| Test Description | Test Method | Lot 1 | Lot 2 | Lot 3 | |
| * Temperature Cycling (-55°C to 125°C, 700 cycles) | JESD22-A104 | 0/25, 0/25 | 0/25, 0/25 | 0/25, 0/25 | |
| * HAST - biased (130 °C/85% RH, 96 Hrs) | JESD22-A110 | 0/25, 0/25 | 0/25, 0/25 | 0/25, 0/25 | |
| High Temperature Storage Bake (150°C, 1000 Hrs) | JESD22-A103 | 0/25, 0/25 | 0/25, 0/25 | 0/25, 0/25 | |
| X-Ray Examination | IDT Spec. MAC- 3012 | 45/5, 45/5 | 45/5, 45/5 | 45/5, 45/5 | |
| Ball Shear Test | JESD22-B117 | 0/5, 0/5 | 0/5, 0/5 | 0/5, 0/5 | |
| Bond Pull Test | MIL-STD-883 (Method 2011) | 0/5, 0/5 | 0/5, 0/5 | 0/5, 0/5 | |
| Moisture Sensitivity Level, MSL | J-STD-20 / MSL 1, 260 °C | 0/25 | 0/25 | - | |

Tests were subjected to Preconditioning per JESD22-A113 prior to stress test

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ATTACHMENT II - PCN # : A1905-01

Affected Part Numbers

| Part Number | Part Number | Part Number | Part Number |
|----------------|--------------|-------------|-------------|
| 74CBTLV3125QG | 9112BF-17LFT | QS3257QG | QS3VH253QG8 |
| 74CBTLV3125QG8 | QS3125QG | QS3257QG8 | QS3VH257QG |
| 74CBTLV3251QG | QS3125QG8 | QS3VH125QG | QS3VH257QG8 |
| 74CBTLV3251QG8 | QS3126QG | QS3VH125QG8 | QS4A101QG |
| 74CBTLV3253QG | QS3126QG8 | QS3VH126QG | QS4A101QG8 |
| 74CBTLV3253QG8 | QS3251QG | QS3VH126QG8 | QS4A205QG |
| 74CBTLV3257QG | QS3251QG8 | QS3VH251QG | QS4A205QG8 |
| 74CBTLV3257QG8 | QS3253QG | QS3VH251QG8 | QS4A210QG |
| 9112BF-17LF | QS3253QG8 | QS3VH253QG | QS4A210QG8 |